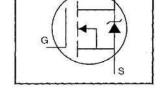
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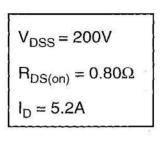
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HEXFET[®] Power MOSFET

- Dynamic dv/dt Rating
- Repetitive Avalanche Rated
- Fast Switching
- Ease of Paralleling
- Simple Drive Requirements
- Lead-Free



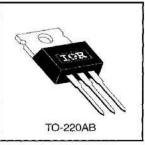
D



Description

Third Generation HEXFETs from International Rectifier provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220 package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 watts. The low thermal resistance and low package cost of the TO-220 contribute to its wide acceptance throughout the industry.



Absolute Maximum Ratings

	Parameter	Max.	Units	
ID @ Tc = 25°C	T _C = 25°C Continuous Drain Current, V _{GS} @ 10 V 5.2			
ID @ Tc = 100°C	Continuous Drain Current, VGS @ 10 V 3.3		A	
IDM	Pulsed Drain Current ①	18		
Pp @ Tc = 25°C	Power Dissipation	50	W	
	Linear Derating Factor	0.40	W/°C	
V _{GS}	Gate-to-Source Voltage	±20	V	
EAS	Single Pulse Avalanche Energy @	110	mJ	
I _{AR}	Avalanche Current ①	5.2	A	
EAR	Repetitive Avalanche Energy ①	5.0	mJ	
dv/dt	Peak Diode Recovery dv/dt ③	5.0	V/ns	
TJ TSTG	Operating Junction and Storage Temperature Range	-55 to +150	°C	
	Soldering Temperature, for 10 seconds	300 (1.6mm from case)		
	Mounting Torque, 6-32 or M3 screw	10 lbf-in (1.1 N-m)		

Thermal Resistance

	Parameter	Min.	Тур.	Max.	Units	
Reac	Junction-to-Case		—	2.5	1	
Recs	Case-to-Sink, Flat, Greased Surface		0.50		°C/W	
Reja	Junction-to-Ambient	-		62		

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	Parameter	Min.	Тур.	Max.	Units	Test Conditions	
V(BR)DSS	Drain-to-Source Breakdown Voltage	200		-	V	VGS=0V, ID= 250µA	
ΔV(BR)DSS/ΔTJ	Breakdown Voltage Temp. Coefficient		0.29	—	V/°C	Reference to 25°C, Ip= 1mA	
RDS(on)	Static Drain-to-Source On-Resistance	-		0.80	Ω	Vgs=10V, Ip=3.1A @	
VGS(th)	Gate Threshold Voltage	2.0		4.0	V	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	
g fs	Forward Transconductance	1.5	10 -0 1		S	VDS=50V, ID=3.1A @	
IDSS	Drain-to-Source Leakage Current	5-10-10	8	25		V _{DS} =200V, V _{GS} =0V	
1055	Drain-to-Source Leakage Current	-	-	250	μA	VDS=160V, VGS=0V, TJ=125	
IGSS	Gate-to-Source Forward Leakage	—	-	100	nΑ	V _{GS} =20V	
1655	Gate-to-Source Reverse Leakage			-100	0A	V _{GS} =-20V	
Qg	Total Gate Charge		-	14		I _D =4.8A	
Q _{gs}	Gate-to-Source Charge		(3.0	nC	V _{DS} =160V V _{GS} =10V See Fig. 6 and 13	
Q _{gd}	Gate-to-Drain ("Miller") Charge		-	7.9	58.5		
t _{d(on)}	Turn-On Delay Time		7.2	—		V _{DD} =100V	
tr	Rise Time	<u>10 -</u> 50	22		ns	I _D =4.8A	
td(off)	Turn-Off Delay Time		19	1	115	R _G =18Ω	
te	Fall Time	-	13	-		R _D =20Ω See Figure 10 @	
Lo	Internal Drain Inductance		4.5	-	nH	Between lead, 6 mm (0.25in.)	
Ls	Internal Source Inductance		7.5	1		from package and center of die contact	
Ciss	Input Capacitance		260	-		V _{GS} =0V	
Coss	Output Capacitance		100		pF	V _{DS} =25V	
Crss	Reverse Transfer Capacitance		30			f=1.0MHz See Figure 5	

Electrical Characteristics @ T_J = 25°C (unless otherwise specified)

Source-Drain Ratings and Characteristics

	Parameter	Min.	Тур.	Max.	Units	Test Conditions
ls	Continuous Source Current (Body Diode)	-	_	5.2	A	MOSFET symbol showing the integral reverse p-n junction diode.
ISM	Pulsed Source Current (Body Diode) (1)	-	-	18		
VSD	Diode Forward Voltage	3 <u>—3</u>	12102	1.8	V	TJ=25°C, IS=5.2A, VGS=0V @
t _{rr}	Reverse Recovery Time	<u></u>	150	300	ns	T_J=25°C, IF=4.8A
Qır	Reverse Recovery Charge		0.91	1.8	μC	di/dt=100A/µs ④
ton	Forward Turn-On Time	Intrinsic turn-on time is neglegible (turn-on is dominated by Ls+Lp)				

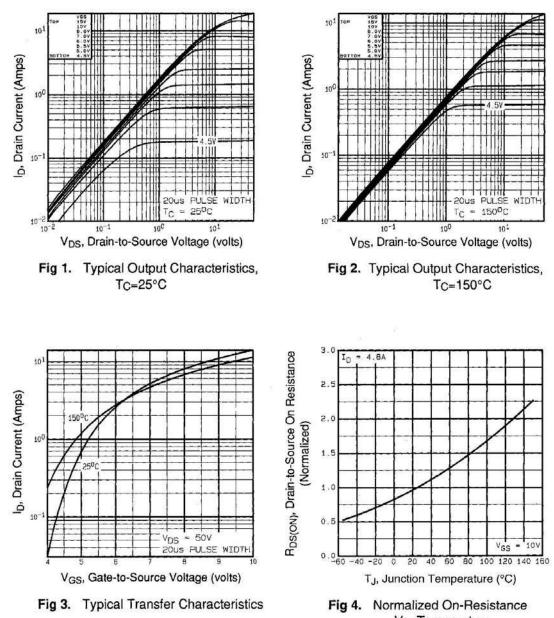
Notes:

 Repetitive rating; pulse width limited by max. junction temperature (See Figure 11) ② V_{DD}=50V, starting T_J=25°C, L=6.1mH RG=25Ω, I_{AS}=5.2A (See Figure 12) ④ Pulse width \leq 300 µs; duty cycle \leq 2%.

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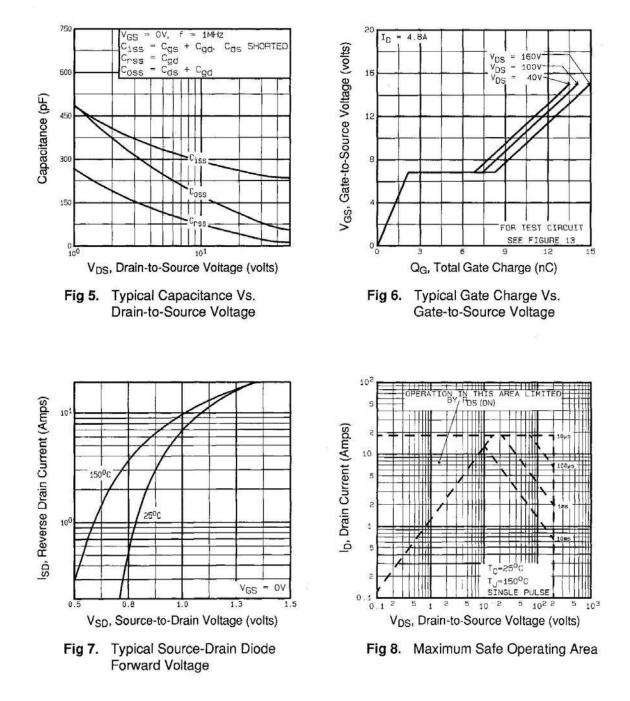


Vs. Temperature

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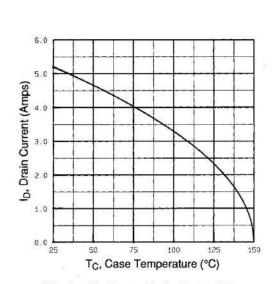
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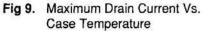
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International

IOR Rectifier



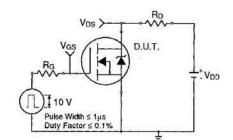


Fig 10a. Switching Time Test Circuit

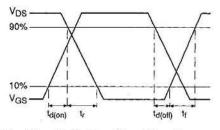


Fig 10b. Switching Time Waveforms

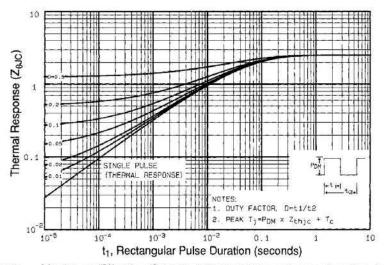


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

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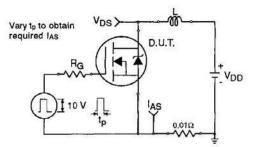


Fig 12a. Unclamped Inductive Test Circuit

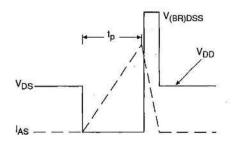


Fig 12b. Unclamped Inductive Waveforms

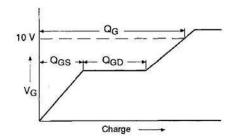


Fig 13a. Basic Gate Charge Waveform

300 01 2.3A 3.3A TOP 3.3A 5.2A BOTTOM EAS, Single Pulse Energy (mJ) 250 200 150 100 50 Vop = 50v 0 Starting T_J, Junction Temperature(°C) 150 25

Fig 12c. Maximum Avalanche Energy Vs. Drain Current

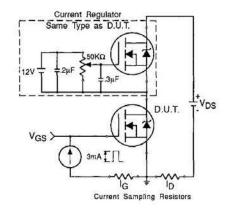


Fig 13b. Gate Charge Test Circuit

Appendix A: Figure 14, Peak Diode Recovery dv/dt Test Circuit – See page 1505 Appendix B: Package Outline Mechanical Drawing – See page 1509

Appendix E: Optional Leadforms - See page 1525

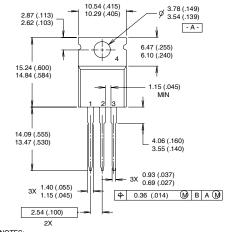
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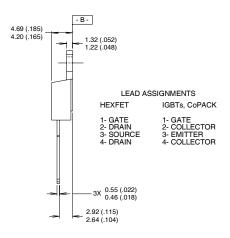




TO-220AB Package Outline

Dimensions are shown in millimeters (inches)





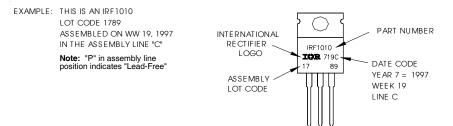
NOTES

1 DIMENSIONING & TOLERANCING PER ANSI Y14.5M, 1982. 2 CONTROLLING DIMENSION : INCH

3 OUTLINE CONFORMS TO JEDEC OUTLINE TO-220AB.

4 HEATSINK & LEAD MEASUREMENTS DO NOT INCLUDE BURRS.

TO-220AB Part Marking Information



Data and specifications subject to change without notice.

International **IOR** Rectifier

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